

OPTICAL DSP

Dove 800/801/802

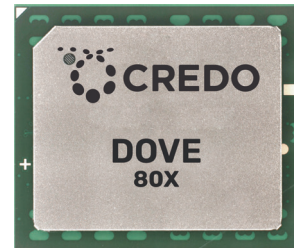
800Gbps DSP (8:8) with Integrated Driver

The Dove 80X family is used in the next-generation, low-power, high-performance 2x (4x106G to 4x106G), or 8x106G to 8x106G PAM-4 OSFP, or QSFP-DD800 optical transceivers for high-density data centers. Dedicated PLLs are included for each transmit and receive data lane enabling seamless operation in breakout applications.

The Dove 80X family integrates high-performance DSP technology and equalization techniques to compensate for optical and electrical impairments while achieving good BER performance and maintaining low power dissipation. This unique architecture is optimized for die size and mainstream silicon process technology, enabling low cost of ownership, and accelerating market adoption.

Dove 800 can be used with external laser or modulator driver, whereas Dove 801 comes with integrated TFLN and EML drivers, and Dove 802 includes a Silicon Photonics driver.

On-chip crossbar, loopbacks and test features simplify module design, bring-up, and production testing.

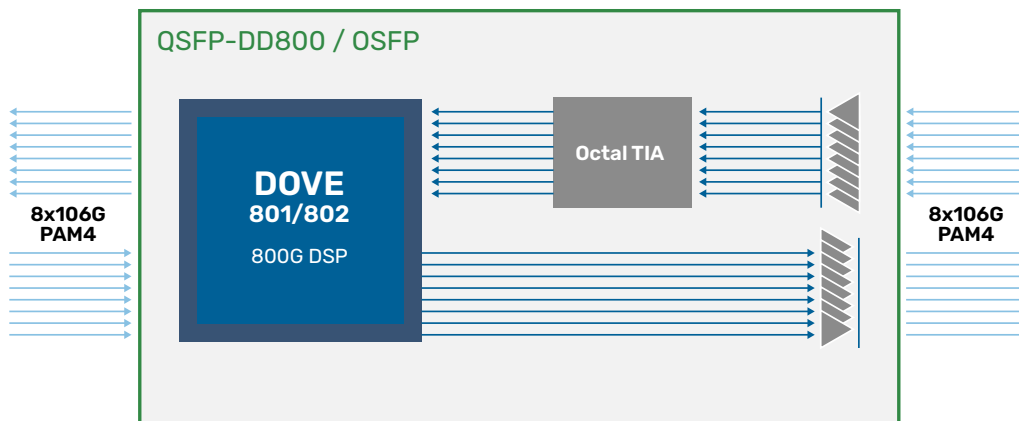


Applications

- Hyperscale data centers
- Cloud networks
- Campus applications
- 800GbE optical transceivers
- 2x400GbE optical transceivers
- Breakout applications

Key Parameters

Host Side	8x106G PAM4
Line Side	8x106G PAM4
Operating Temp	0° to 85°C



Key Features

- Powerful DSPs on optical line side and electrical host side deliver industry leading sensitivity and BER performance, allowing margin for optical alignment and crosstalk.
- Line side receivers include non-linear cancellation and reflection cancellation, which improves yields and reduces module cost.
- High-performance transmitters come with multi-tap FIR filters and non-linear cancellation, allowing precision optimization at both the module electrical connector and the optical interface
- Host side interface supports up to 30dB insertion loss channel, connecting seamlessly with different length switch interfaces without need for customized per-channel settings.
- The family comes with EML, TFLN and Silicon Photonics drivers and bias-T but allows use with external laser or modulator driver support to provide customers with maximum flexibility.
- Independent phase locked loops per channel support flexible breakout configurations including 2x400GbE, 4x200GbE and 8x100GbE.
- Full suite of test features and loopbacks simplifies lab bring-up, production testing and reduces time-to-market.
- On-chip crossbar simplifies module layout design.
- Low power dissipation enables higher rack utilization and lower thermal cooling requirements.

Supported Standards and Interfaces

- 800G-SR8/DR8/FR8/LR8
- 2x400G-SR4/DR4/FR4/LR4
- 4x200G-SR2/DR2/FR2/LR2
- 8x100G-SR/DR/FR/LR
- 100GAUI-1, 400GAUI-4, 800GAUI-8
- OSFP and QSFP-DD800
- CMIS 4.0 and 5.0

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